HVC379B

Variable Capacitance Diode for VCO

HITACHI

ADE-208-817 (Z) Rev 0 Aug. 1999

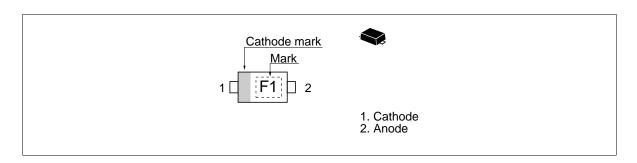
Features

- High capacitance ratio. (n =1.80min)
- Low series resistance. (rs= 1.0Ω max)
- <u>U</u>ltra small <u>F</u>lat <u>P</u>ackage (UFP) is suitable for surface mount design.

Ordering Information

| Type No. | Laser Mark | Package Code |
|----------|------------|--------------|
| HVC379B | F1 | UFP |

Outline





HVC379B

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

| Item | Symbol | Value | Unit |
|----------------------|--------|-------------|------|
| Reverse voltage | V_R | 10 | V |
| Junction temperature | Tj | 125 | °C |
| Storage temperature | Tstg | -55 to +125 | °C |

Electrical Characteristics (Ta = 25°C)

| Item | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------|------------------|------|-----|------|------|------------------------------------|
| Reverse current | I _{R1} | _ | _ | 10 | nA | V _R = 10V |
| | I _{R2} | _ | _ | 100 | | V _R = 10V, Ta= 60°C |
| Capacitance | C _{0.5} | 2.90 | _ | 3.20 | pF | V _R = 0.5V, f = 1MHz |
| | C _{2.5} | 1.25 | _ | 1.53 | | V _R = 2.5V, f = 1MHz |
| Capacitance ratio | n | 1.80 | _ | _ | _ | C _{0.5} /C _{2.5} |
| Series resistance | r _s | _ | _ | 1.0 | Ω | V _R = 1V, f = 470MHz |

Main Characteristic

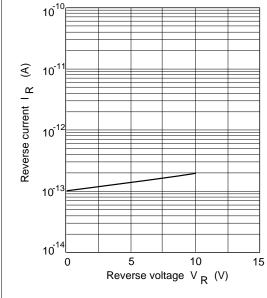


Fig.1 Reverse current Vs. Reverse voltage

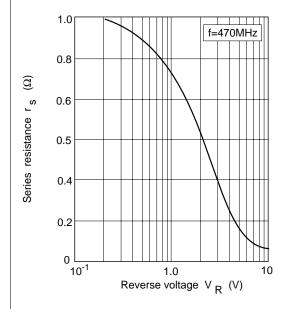


Fig.3 Series resistance Vs. Reverse voltage

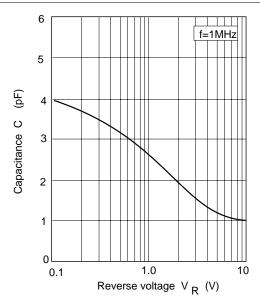


Fig.2 Capacitance Vs. Reverse voltage

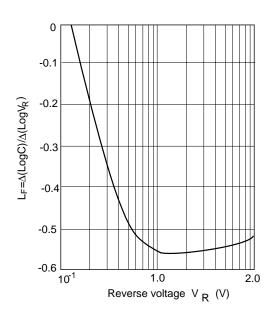
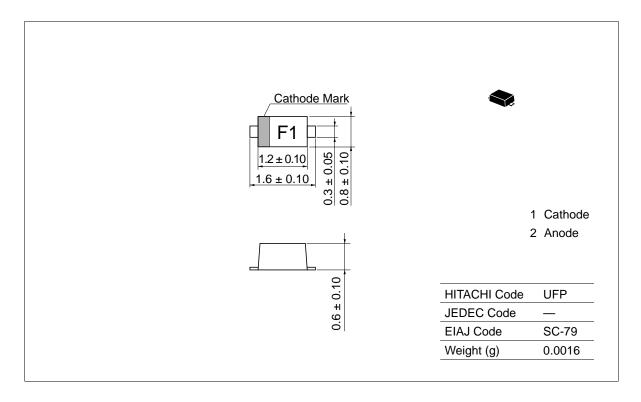


Fig.4 Linearity factor Vs. Reverse voltage

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Package Dimensions

Unit: mm



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